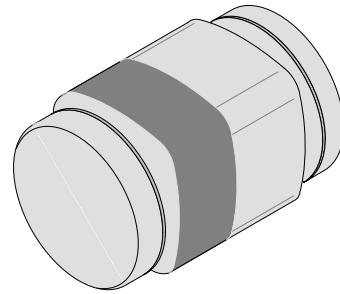


Micro Melf Switchind diode

Features

- Saving space
- Hermetic sealed parts
- Fits onto SOD 323 / SOT 23 footprints
- Electrical data identical with the devices 1N4148 and 1N4448 respectively
- Micro Melf package



Pb Free Product

Applications

Extreme fast switches

Absolute Maximum Ratings

$T_j = 25^\circ\text{C}$

Parameter	Test Conditions	Type	Symbol	Value	Unit
Repetitive peak reverse voltage			V_{RRM}	100	V
Reverse voltage			V_R	75	V
Peak forward surge current	$t_p=1\mu\text{s}$		I_{FSM}	2	A
Repetitive peak forward current			I_{FRM}	450	mA
Forward current			I_F	200	mA
Average forward current	$V_R=0$		I_{FAV}	150	mA
Power dissipation			P_V	500	mW
Junction temperature			T_j	175	°C
Storage temperature range			T_{stg}	-65...+175	°C

Maximum Thermal Resistance

$T_j = 25^\circ\text{C}$

Parameter	Test Conditions	Symbol	Value	Unit
Junction ambient	mounted on epoxy–glass hard tissue, Fig. 1, 35 μm copper clad, 0.9 mm ² copper area per electrode	R_{thJA}	500	K/W

Electrical Characteristics

$T_j = 25^\circ\text{C}$

Parameter	Test Conditions	Type	Symbol	Min	Typ	Max	Unit
Forward voltage	$I_F=5\text{mA}$	MCL4448	V_F	0.62		0.72	V
	$I_F=50\text{mA}$	MCL4148	V_F		0.86	1	V
	$I_F=100\text{mA}$	MCL4448	V_F		0.93	1	V
Reverse current	$V_R=20\text{V}$		I_R			25	nA
	$V_R=20\text{V}, T_j=150^\circ\text{C}$		I_R			50	μA
	$V_R=75\text{V}$		I_R			5	μA
Breakdown voltage	$I_R=100\mu\text{A}, t_p/T=0.01, t_p=0.3\text{ms}$		$V_{(BR)}$	100			V
Diode capacitance	$V_R=0, f=1\text{MHz}, V_{HF}=50\text{mV}$		C_D			4	pF
Rectification efficiency	$V_{HF}=2\text{V}, f=100\text{MHz}$		η_r	45			%
Reverse recovery time	$I_F=I_R=10\text{mA}, i_R=1\text{mA}$		t_{rr}			8	ns
	$I_F=10\text{mA}, V_R=6\text{V}, i_R=0.1 \times I_R, R_L=100\Omega$		t_{rr}			4	ns

Characteristics ($T_j = 25^\circ\text{C}$ unless otherwise specified)

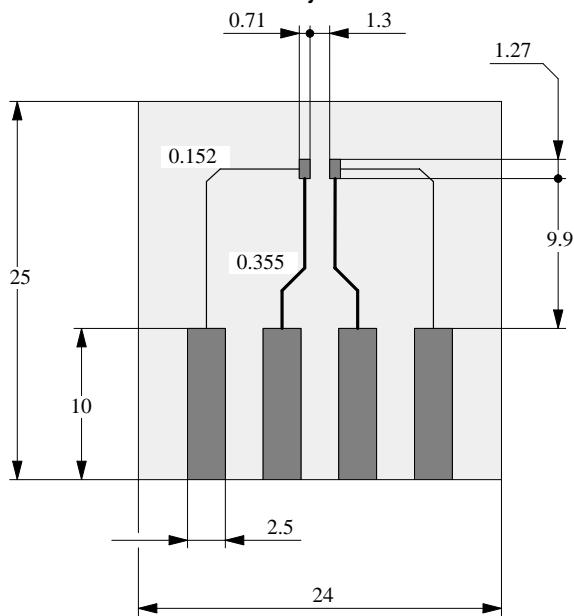


Figure 1. Board for R_{thJA} definition (in mm)

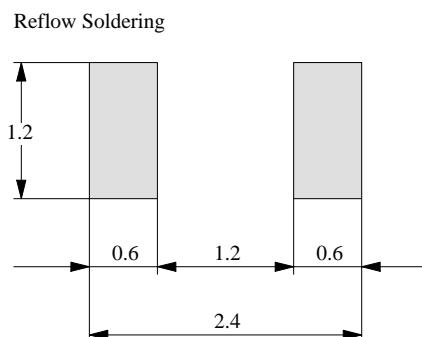


Figure 2. Recommended foot pads (in mm)

Reflow Soldering

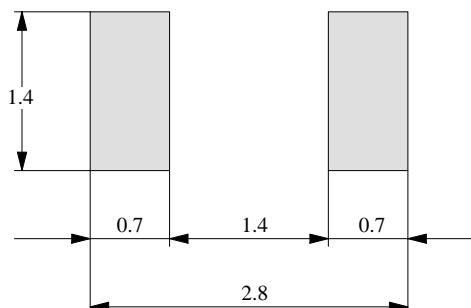


Figure 3. Recommended foot pads (in mm)

Wave Soldering

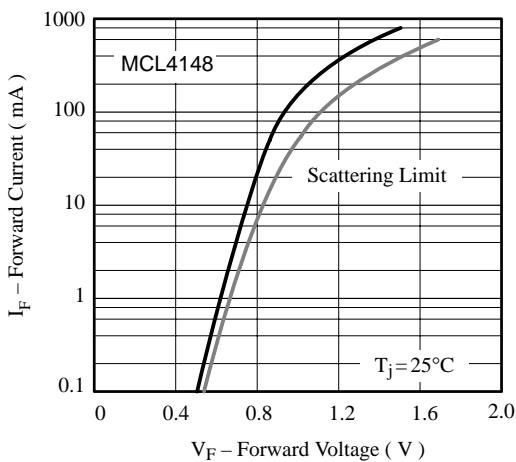


Figure 4. Forward Current vs. Forward Voltage

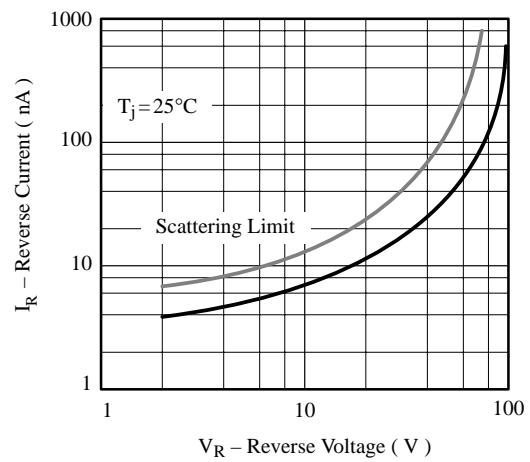


Figure 6. Reverse Current vs. Reverse Voltage

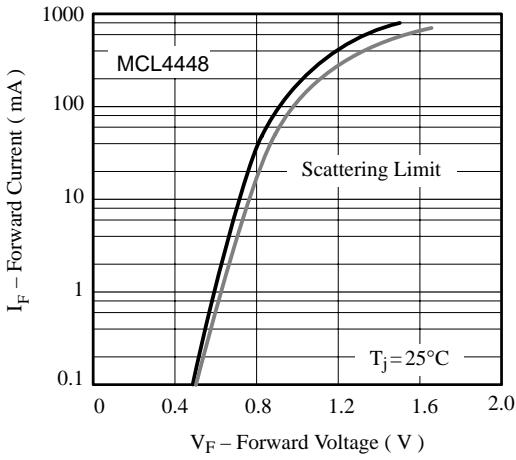


Figure 5. Forward Current vs. Forward Voltage

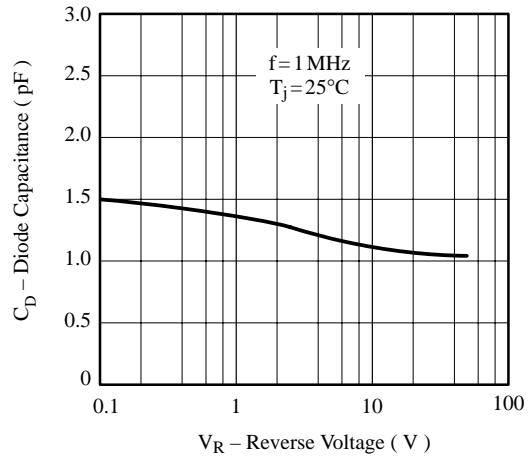
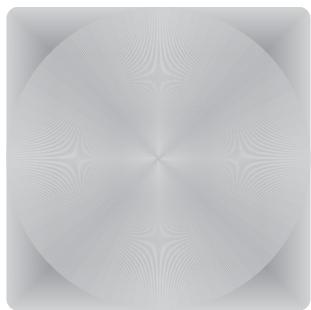


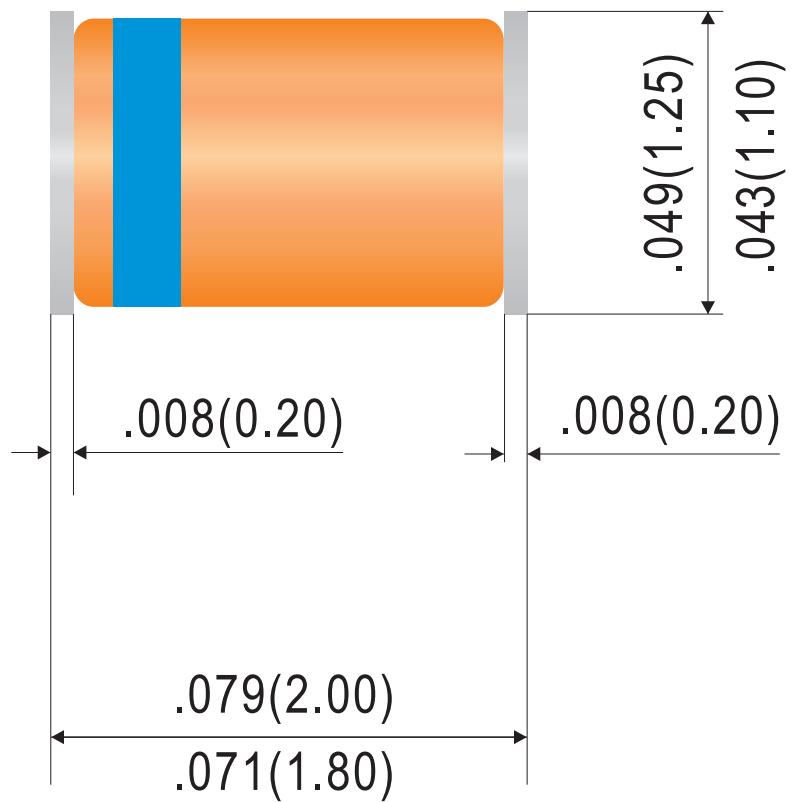
Figure 7. Diode Capacitance vs. Reverse Voltage

Outline Drawing

MICRO-MELF



.043(1.10)



Dimensions in inches and (millimeters)

Rev.B